

Startup Snowmass
Sub –Topic IF-7
Electronics & ASICs

Sept 24, 2021

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LOI Submissions Directed to IF07 topic as Primary *as of Sept 15, 2020*

IF 7 LOI Summary September 15, 2020

PDF Reference

SNOWMASS21-IF7_IF0-073
 SNOWMASS21-IF7_IF0_Frank_Krennrich-173
 SNOWMASS21-IF7_IF1_Carl_Grace-109
 SNOWMASS21-IF7_IF2-NF10_NF0_Analog_Photon_Processor-052
 SNOWMASS21-IF7_IF3_Leo_Greiner-160
 SNOWMASS21-IF7_IF4_Sandeep_Miryala-180
 SNOWMASS21-IF7_IF4-132
 SNOWMASS21-IF7_IF5_H.MULLER-101
 SNOWMASS21-IF7_IF8-NF10_NF0_Jonathan_Asaadi-079
 SNOWMASS21-IF7_IF8-NF10_NF0-UF3_UF0_Dan_Dwyer-171
 SNOWMASS21-IF7_IF9-CF2_CF4_Austin_Minnich-117

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Description

Technology Specific	Near Term	Continued Development	Quality Control	Existing F E Electronics Tech to implement novel detector readout
X				
	X			
		X		
	X			
	X			
X				
			X	
			X	
	X			

Technology Specific Near Term Continued Development
 Technology Specific Long Term Investigation
 Quality Control technique for Extreme Environments
 Existing F E Electronics Tech to implement novel detector readout

Totals 2 5 1 3

A few months back – before the pause

Started to work on consolidating from LOIs to white papers

From LOIs to white papers

- Data handling
 - Addressable Readout Techniques for Scaleable Readout System
 - Self-driving data trigger, filtering, and acquisition systems for high-throughput physics facilities
 - Real-time adaptive deep-learning with embedded systems for discovery science
 - FPGA Based Artificial Intelligence Inference In Triggered Detectors
- AI/ML
 - Self-driving data trigger, filtering, and acquisition systems for high-throughput physics facilities
 - Real-time adaptive deep-learning with embedded systems for discovery science
 - FPGA Based Artificial Intelligence Inference In Triggered Detectors
 - AI ASICs for front end processing focus on Optimal Implementation
 - ML and AI data inferential reduction

A few months back – before the pause

Started to work on consolidating from LOIs to white papers

From LOIs to white papers

- Pixelated Liquid Noble readouts
 - Pixelated LAR_TPC ionization current Reconstruction Technique
 - Pixelated LAR_TPC Readout Establish R&D mechanisms
- Monolithic sensor readout
 - Large area CMOS monolithic active pixel sensors for future colliders
 - 28nm CMOS for 4D Tracker Readout Chips
 - 4-Dimensional Trackers
 - BNL & LBL MAPs Tracker development

A few months back – before the pause

Started to work on consolidating from LOIs to white papers

From LOIs to white papers

- Calorimetry
 - High precision, high dynamic range readout
- Optical links
 - Optical Link HS (xtreme radiation environment)
 - Radiation-hard high-speed fiber-optical data links for HEP experiments
- Timing
 - Time of Flight Detector for circular electron positron collider
 - PRECISION TIMING DETECTORS FOR FUTURE COLLIDERS

A few months back – before the pause

Started to work on consolidating from LOIs to white papers

From LOIs to white papers

- Deep cryogenic readout
 - 4K and below Cryo SiGe heterogenous bipolar
- Design for reliability analytical techniques
 - Quality Control Cryogenic Detector FE Readout
- Photodetector readout
 - Analog Processor with parametric feature Extraction

Organizational Meeting Sept 13, 2021

- Reviewed IF7 LOIs White Paper worthy sub-topics from 2020
- Starting consolidating/coordinating on a few areas:
 - ASIC Workforce/tools/Foundries
 - Calorimetry
 - Photodetectors
 - Silicon Sensors
 - TDAQ
- IF7 - Strong connection established (last year) with:
 - TDAQ/Triggering (IF4)
 - Solid State Detectors /Tracking (IF3)

IF7 related contributions will likely be merged into IF3 and IF4 white papers.

Meanwhile: progress on ASIC Workforce/tools/Foundries

Our CPAD community discussion concluded that there was movement towards direct support for instrumentation and, in fact, two FOA's from DOE appeared in the Spring that included some wording from the 2019 BRN Instrumentation report.

Microelectronics Co-Design Research LAB opportunity

and

Traineeship in High Energy Physics University Program

This year we have participated in discussions with ASIC foundry representatives to explore opportunities for multi-party NDA's.

Notably:

Skywater (open source technology) & TSMC (commercially vetted)

We expect to continue to pursue opportunities through the HEPIC and follow the progress of the 3 funded Traineeship programs.

Next immediate steps – our plans

- Refresh meetings with our group and connections with other IF groups
- Invite speakers to update & invigorate progress on white papers